Date: March, 2001



(SCM7591-XC)



# Technical Specification for

# **Optical Transceiver Module**

# SCM7591-XC

<b>.</b>			
1	55.52Mb/s	622.08Mb/s	other
107	Short Haul ntermediate Reach	Long Haul	other
	Single 5.0 V	Long Reach Single 3.3 V	other
1	.3 µm	1.55 µm	other
	ransmitter	Receiver	Transceiver
		(  2R /  3R )	( Z 2R / 3R )
			,
	Sl	JMITOMO ELECTF	RIC
SUMITOMO Electri	c reserves the right to m	ake changes in the specification	ation described hereinafter without prior
notice.			
#Safety Preca			symbols to prevent possible injury to operator or
	e to properties for appropriate ols before reading this specific		and definitions are as shown below. Be sure to be
		owing this instruction may lead to h	numan death or serious injury.
	Wrong operation without follo	owing this instruction may lead to h	uman injury or property damage.
Example of picture symb	pols indicates prohibition	n of actions. Action details are exp	lained nearby.
	<u> </u>	rv actions or instructions. Action d	

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#### 1. General

SCM7591-XC is a series of compact and high speed performance digital optical transceiver module ideally designed for versatile high speed network applications. 1300nm high speed InGaAsP-LD and InGaAs PIN-PD are provided as a light source and a detector, respectively. Transceiver module has PC board mountable package with electrical and optical interfaces.

\* Data Rate 155.52 Mbps, NRZ

\* Duty Cycle 50%

\* Power Supply Voltage Single +3.3V \* Electrical Interface PECL(Data)

\* Fiber Coupled Power  $-8 \sim -15$ dBm (Typ. -11dBm) for SMF

\* Sensitivity -8 ~ -28dBm

\* Connector Interface SC Duplex Connector

The features of SCM7591-XC are listed below.

\* Features Low Power Supply Voltage / Low Power Consumption

> Plastic Molded Package Multi-sourced Footprint

Uncooled Laser with Automatic Power Control IC Transmitter.....

Optical Output Shut-down (Disable)

Laser Bias Current Monitor / Optical Output Power Monitor

Class 1 Laser Product (IEC 825-1 and FDA 21 CFR 1040.10 and 1040.11)

Receiver..... Wide Dynamic Range

ITU-T G.957 / G.958 and Bellcore TA-NWT-000253 Compliant Signal Detect (FLAG) Function / Optical Input Power Monitor

## 2. Block Diagram

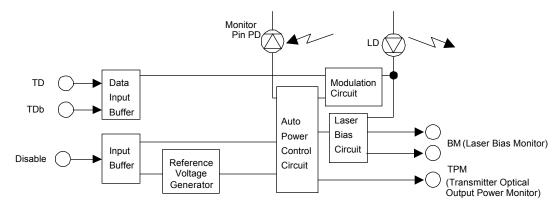


Figure 1-1. Block Diagram (Transmitter)

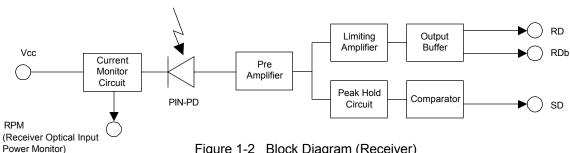


Figure 1-2 Block Diagram (Receiver)

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# 3. Package Dimension

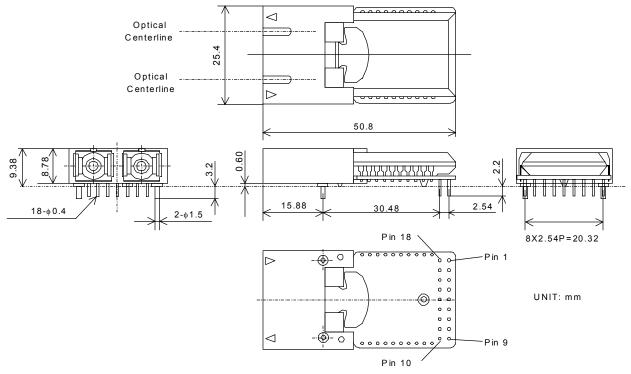


Figure 2. Package Dimension

## **∆** Caution

 $\bigcap$  Do not disassemble this product. Otherwise, failure, electrical shock overheating or fire may occur.

Handle the lead pin carefully. Use assisting tools or prospective aids as required. A lead pin may injure skin or human body

## 4. Pin Assignment

No.	Symbol	Function
1	NC	Non Connection (Internally)
2	NC	Non Connection (Internally)
3	NC	Non Connection (Internally)
4	NC	Non Connection (Internally)
5	BM(-)	Monitoring pin for LD Bias Monitor
6	BM(+)	Monitoring pin for LD Bias Monitor
7	Disable	LD Disable Input
8	RPM	Receiver Optical Input Power Monitor
9	TPM	Transmitter Optical Output Power Monitor
10	Veetx	Power Supply (-) for Transmitter : Connected to GND
11	TD	Transmitter Differential Data (Positive)
12	TDb	Transmitter Differential Data (Negative)
13	Vcctx	Power Supply (+) for Transmitter : Connected to +3.3V
14	Vccrx	Power Supply (+) for Receiver : Connected to +3.3V
15	FLAG(SD)	FLAG (Signal Detect)
16	RDb	Received Differential Data (Negative)
17	RD	Received Differential Data (Positive)
18	Veerx	Power Supply (-) for Receiver : Connected to GND

NC pins should be left open for additional functions in the future

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### 5. Absolute Maximum Ratings

Parameter		Symbol	min.	Max	Unit	Note
Storage Case Temperature		Ts	-40	85	°C	1
Operating Case Teperature		Tc	-5	70	°C	1,2
		10	-40	85	°C	1,3
Supply Voltage		Vcc	0.0	4.0	V	4
Input Voltage		Vi	0.0	Vcc+0.5	V	5
Load Caldaring	Temperature			260	°C	6
Lead Soldering	Time			10	sec.	6

Note 1. No condensation allowed. 2.SCM7591-XC 3.SCM7591-XC-W

4. Vcc=+3.3V 5. TD, TDb, Disable 6. Measured on lead pin at 2mm (0.079in.) off the package bottom

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Use the product with the rated voltage described in the specification. If the voltage exceeds the maximum rating, overheating or fire may occur.

#### Caution

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Do not store the product in the area where temperature exceeds the maximum rating, where there is too much moisture or dampness, where there is acid gas or corrosive gas, or other extreme conditions. Otherwise, failure, overheating or fire may occur.

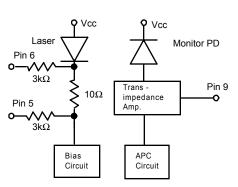
#### Electrical Interface

(Unless otherwise specified, Vcc = 3.14 to 3.47 V and all operating temperature shall apply.)

#### 6-1. Transmitter side

Paramete	r	Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc	3.14	3.30	3.47	V	
Supply Current		ldtx		70	140	mA	1, 2, 3, 4
Supply Current		TULX		70	150	IIIA	1, 2, 3, 5
Input Voltage	High	Vih	Vcc-1.17		Vcc-0.73	V	6, 7
TD, TDb	Low	Vil	Vcc-1.95		Vcc-1.45		
Input Current	High	lih	-10		150	μΑ	6, 7
TD, TDb	Low	lil	-10		10		
Signal Input Rise / Fall Time					1.5	nsec.	8
Disable Input Voltage		Vdi	2.0		Vcc	V	9
Disable Input Current		ldi	-10	140	200	μΑ	
Enable Input Voltage		Vei	0.0		0.8	V	1
LD Bias Monitor Voltage		Vbm	0.01	0.05	0.50	V	7, 10
	Low level				0.2	V	11
Optical Output Monitor	Normal	Vtpm		0.6			
	High level	1	1.1				

Note 1. Input bias current is not included. 2. 50% duty cycle data 3. 155.52Mbps 4.SCM7591-XC 5.SCM7591-XC-W 6. Vcc=+3.3V 7. Tc=25°C 8. 20~80% 9. The transmitter is enabled as default state and requires an external voltage only to disable. (Refer to Section 8. Relation between Disable Input Voltage and Optical Output Power ) 10. The Laser Bias Monitor Current are calculated as ratios of the corresponding voltages to their current-sensing resistor,  $10\Omega$  (See Figure 3). Upon Measuring or utilzing these values, please use a device whose Impedance is high enough (>1M $\Omega$ ) compared with those resistors. 11. The relationship between the Output Power Change and the Tranmitter Optical Power Monitor Voltage is shown in Figure 4.



Fugure 3. Monitor Pin

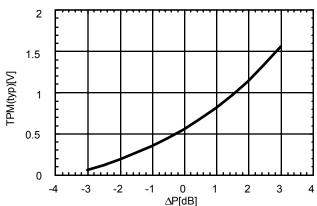


Figure 4. Output Power Change versus the Optical Output Monitor Voltage (typ.)

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#### 6-2. Receiver side

Paramet	er	Symbol	min.	Тур.	Max.	Unit	Note
Supply Voltage		Vcc	3.14	3.30	3.47	V	
Supply Current		Idrx		95	125	mA	1
Data and SD(FLAG)	High	Voh	Vcc-1.10		Vcc-0.86	V	2
Output Voltage	Low	Vol	Vcc-1.86		Vcc-1.62		
Data Rise / Fall Time	•	Trd / Tfd			1000	psec.	3
SD (FLAG) Assert Time		Та			100	μsec	4
SD(FLAG) Deassert Tim	ie	Td			350	μsec	
Optical Input Power Mon	nitor @-20dBm	Vrpm		2.5		V	5
	@-34dBm			0.1			

#### Note

- 1. Output current is not included. 155.52Mbps, PRBS2^23-1.
- 2. Vcc=+3.3V, Tc=25°C, Output load resistance RI=50 $\!\Omega$  to Vcc-2V for RD, RDb and FLAG.
- 3. 20~80%
- 4. 155.52Mbps, PRBS 2^23-1, NRZ
- 5. The relationship between the Optical Input Power and the Optical Input Monitor Voltage is shown in Figure 5.

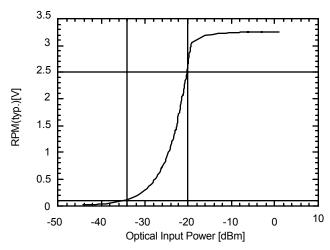


Figure 5. lutput Power versus the Optical Input Monitor Voltage (typ.)

## 7. Optical Interface

(Unless otherwise specified, Vcc = 3.14 to 3.47 V and all operating temperature shall apply.)

#### 7-1. Transmitter side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note		
Average Output Power	Po	-15.0		-8.0	dBm	1		
Extinction Ratio	Er	8.2			dB	1		
Center Wavelength	λς	1261		1360	nm			
Spectral Width (RMS)	Δλ			7.7	nm			
Eye Mask for Optical Output		Refer to Figure 6						

Note 1. Measured at 155.52Mbps PRBS2^23-1

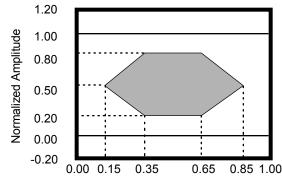


Figure 6 Optical Pulse Mask with Fourth Order Bessel-Thomson Filter Specified in ITU-T G.957

# Relation between Input Signal and Optical Output Signal

Input	Signal	Optical Output Signal				
TD	TDb	Optical Output Signal				
High	Low	ON (High)				
Low	High	OFF (Low)				
High	High	Undefined				
Low	Low	Undefined				

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Do not look at the laser beam projection area (e.g. end of optical connector) with naked eyes or through optical equipment while the power is supplied to this product. Otherwise, your eyes may be injured.

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#### 7-2. Receiver side

Parameter	Symbol	min.	Тур.	Max.	Unit	Note
Center Wavelength	-	1261		1580	nm	
Minimum Sensitivity	Pmin			-28.0	dBm	1, 2
Overload	Pmax	-8.0			dBm	1, 2
Flag Assert Level	Pa		-37		dBm	
Flag Deassert Level	Pd		-40		dBm	2
FLAG Hysteresis	Phys		3		dB	
Note 1. BER=10^-10			•			

<sup>2.</sup> Measured at the bit rate of 155.52Mbps, PRBS 2^23-1, NRZ

## 8. Relation between Disable Input Voltage and Optical Output Power

Disable Input Voltage	Optical Output Power
"L"(0.0 ~ 0.8V)	Enabled
"H"(2.0V ~ Vcc)	Disabled (<-45dBm)

## 9. Reliability Test

GR-468-CORE Issue 1, December 1998 Laser Module

HEADING	TEST	REFERENCE	CONDITIONS	SAMP	LING	;	EΝV	/'T	Sum	itomo Result
				LTPD	SS	С	СО	RT/	SS	Pass/Fail
								UNC		
	Mechanical	MIL-STD-883	5 times/axis							
	Shock	Method 2002	w/o TEC 1,500G, 0.5ms	20	11	0	R	R	11	Pass
	Vibration	MIL-STD-883	Cond. A 20G, 20-2,000G	20	11	0	R	R	11	Pass
Mechanical		Method 2007	Hz, 4min/cy, 4cy/axis							
Integrity	Thermal Shock	MIL-STD-883	Delta T=100degC	20	11	0	R	R	11	Pass
		Method 1011	0degC to 100degC							
	Solderability	MIL-STD-883	(steam aging not	20	11	0	R	R	11	Pass
		Method 2003	required)							
	Accel. Aging	(R)-4-53 Section	85degC; rated power			-				
	(High Temp.)	5.18	2,000 hrs.	-	25		-	R	25	Pass
			5,000 hrs.		10			0	25	Pass
Endurance	Low Temp.	-	min, storage T	20	11	0	0	0	11	Pass
	Storage		2,000 hrs.							
	Temperature	Section 5.20	-40degC to +85degC							
	Cycling		500 pass/fail	20	11	0	-	R	11	Pass
			1,000 for info.	-	11	-		R	11	Pass
	Damp Heat	MIL-STD-202	85degC/85%RH 1,000hrs.	20	11	0	R	R	11	Pass
		Method 103 or								
		IEC-68-2-3								
	Cyc. Moist,. Res.	Sec. 5.23	-	20	11	0	-	R	11	Pass
Special Tests	Internal	MIL-STD-883	Max. 5,000ppm water	20	11	0	R	R	11	Pass
	Moisture	Method 1018	vapour							
	ESD Threshold	Section 5.22	corresponding number of all		6		R	R	6	

LTPD (in %); min. acceptable sample size(SS) and corresponding number of allowed failures (C)

CO; Conditional Objective

RT/UNC; Room Temp. / Uncontrol

R; Requirement

O; Objective

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### 10. Laser Safety

This product uses a semiconductor laser system and is a laser class 1 product acceptable FDA, complies with 21CFR 1040. 10 and 1040.11. Also this product is a laser class 1 product acceptable IEC 825-1.

#### 11. Other Precaution

Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

The governmental approval is required to export this product to other countries. To dispose of these components, the appropriate procedure should be taken to prevent illegal exportation.

This module must be handled, used and disposed of according to your company's safe working practice.

## **△** Warning



Be sure to carry out correct soldering for connection to peripheral circuits in order to prevent contact failure or short-circuit. Otherwise, a strong laser beam may cause eye injury, overheating or fire.

Do not put this product or components of this product into your mouth. This product contaions material harmful to health.

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Be sure to turn the power off when you touch this product connected to the printed circuit boards. Otherwise, electric shock may occur.

Dispose this product or equipment including this product properly as an industrial waste according to the regulations.

## 12. Ordering Information

Ordering Number	Connector type	Operating Temparature
SCM7591-XC	SC Duplex Connector	Tc = -5~70°C
SCM7591-XC-W	SC Duplex Connector	Tc = -40~85°C

#### 13. For More Information

U.S.A.

ExceLight Communications, 4021 Stirrup Creek Drive, Suite 200 Durham, NC 27703

Tel. +1-919-361-1600 / Fax. +1-919-361-1619

E-mail: info@excelight.com http://www.excelight.com

Europe

Sumitomo Electric Europe Ltd., 220, Centennial Park, Elstree, Herts, WD6 3SL, United Kingdom

Tel.+44-208-953-8681 Fax.+44-208-207-5950

E-mail: photonics@sumielectric.com

http://www.sumielectric.com

#### Japan

Sumitomo Electric Industries, Ltd. (International Business Division), 3-12, Moto-Akasaka 1-chome Minato-ku Tokyo 107-8468

Tel. +81-3-3423-5771 / Fax. +81-3-3423-5099

E-mail:product-info@ppd.sei.co.jp

http://www.sei.co.jp/Electro-optic/index\_e.html

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